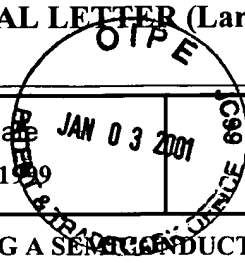
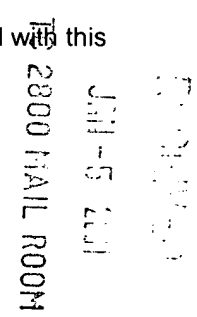
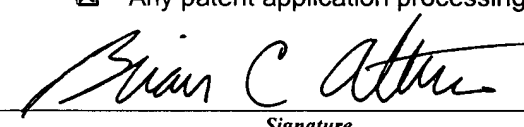


AMENDMENT TRANSMITTAL LETTER (Large Entity)				Docket No. SEC.636	
Applicant(s): Won-suk YANG et al.					
Serial No. 09/313,659	Filing Date May 18, 1999		Examiner S. Rao	Group Art Unit 2814	
Invention: METHOD FOR FABRICATING A SEMICONDUCTOR DEVICE					
<u>TO THE ASSISTANT COMMISSIONER FOR PATENTS:</u>					
Transmitted herewith is an amendment in the above-identified application.					
The fee has been calculated and is transmitted as shown below.					
CLAIMS AS AMENDED					
	CLAIMS REMAINING AFTER AMENDMENT	HIGHEST # PREV. PAID FOR	NUMBER EXTRA CLAIMS PRESENT	RATE	ADDITIONAL FEE
TOTAL CLAIMS	19 -	20 =	0 x	\$18.00	\$0.00
INDEP. CLAIMS	2 -	3 =	0 x	\$80.00	\$0.00
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					\$0.00
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT					\$0.00
<div style="display: flex; justify-content: space-between;"> <div style="width: 60%;"> <input checked="" type="checkbox"/> No additional fee is required for amendment. <input type="checkbox"/> Please charge Deposit Account No. _____ in the amount of _____ A duplicate copy of this sheet is enclosed. <input type="checkbox"/> A check in the amount of _____ to cover the filing fee is enclosed. <input checked="" type="checkbox"/> The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 50-0238 A duplicate copy of this sheet is enclosed. <input checked="" type="checkbox"/> Any additional filing fees required under 37 C.F.R. 1.16. <input checked="" type="checkbox"/> Any patent application processing fees under 37 CFR 1.17. </div> <div style="width: 35%; text-align: right;">  </div> </div> <div style="margin-top: 20px;"> <div style="display: flex; justify-content: space-between; align-items: center;"> <div style="text-align: center;">  <i>Signature</i> </div> <div> Dated: January 3, 2001 </div> </div> <div style="margin-top: 10px;"> BRIAN C. ALTMILLER REG. NO. 37,271 JONES VOLENTINE, L.L.C. 12200 SUNRISE VALLEY DRIVE, SUITE 150 RESTON, VIRGINIA 20191 (703) 715-0870 </div> </div>					
<div style="border: 1px solid black; padding: 5px;"> I certify that this document and fee is being deposited on _____ with the U.S. Postal Service as first class mail under 37 C.F.R. 1.8 and is addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231. </div> <div style="border: 1px solid black; padding: 5px; margin-top: 10px;"> <i>Signature of Person Mailing Correspondence</i> </div> <div style="border: 1px solid black; padding: 5px; margin-top: 10px;"> <i>Typed or Printed Name of Person Mailing Correspondence</i> </div>					
CC:					

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of:

Won-suk YANG et al.

Group Art Unit: 2814

Application Serial No.: 09/313,659

Examiner: S. Rao

Filed: May 18, 1999

Title: METHOD FOR FABRICATING A SEMICONDUCTOR DEVICE

Assistant Commissioner of Patents
Washington, D.C. 20231

SUPPLEMENTAL AMENDMENT

Please consider the following amendments in this case.

IN THE SPECIFICATION:

Please amend the specification as follows:

Page 13, line 20, change "20 KeV" to --50 KeV--.

REMARKS

In this Supplemental Amendment, Applicants are amending the specification to correct a typographical error. In particular, on page 13, the implantation energy is improperly given as being 20 KeV, rather than 50 KeV.